Docket Number (Optional) MR2685-105

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sol names are listed below) of the subject			
METHOD FOR PREPARING THIN I	BER-STRUCTURED POLYM	ER WEB	, the specification of which is
attached hereto unless the following b	ox is checked:		
was filed on	as United States Application Number or PCT International Application		
Number	and was amended on (if applicable).		
I hereby state that I have reviewed an amended by any amendment referred acknowledge the duty to disclose informer in the late of the late	to above. ormation which is material to punder 35 U.S.C. § 119(a)-(d) ernational application which de by checking the box, any fore	patentability as defined in 37 CFR or § 365(b) of any foreign applicates signated at least one country other ign application for patent or invent	§1.56. lon(s) for patent or inventor's er than the United States, listed
2001-3685	KR	26 January 2001	
(Number)	(Country)	(Day/Month/Year Filed)	
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(Number)	(Country)	(Day/Month/Year Filed)	
hereby claim the benefit under 35 U.	S.C. § 119(e) of any United S	tates provisional application(s) liste	ed below.
	(Filing Da	tol	
(Application Number)	(Filling Da	(6)	
(Application Number)	(Filing Da	te)	
designating the United States, listed to in the prior United States or PCT Intel acknowledge the duty to disclose information between the filling date of the prior ap	rnational application in the ma formation which is material to p	nner provided by the first paragrap patentability as defined in 37 CFR	sh of 35 U.S.C. § 112. § 1.56 which became available
(Application Number)	(Filing Da	ite) (Status-pate	ented, pending, abandoned)
(Application Number) I hereby appoint the following attorne Trademark Office connected therewith Address all telephone calls to Address all correspondence to	DE MORTON J. ROSENBERG DAVID I. KLEIN, ESQ., REI MORTON J. ROSENBERG ROSENBERG, KLEIN & LE 3458 ELLICOTT CENTER'I ELLICOTT CITY, MD 2104 FAX #: 410-461-3067	ute this application and to transact i, ESQ., REG. # 26,049; G. # 33,253; JUN Y. LEE, ESQ., R i at telephone number 410-465-66 EE DRIVE-SUITE 101	EG. # 40,262
,	E-MAIL ADDRESS: rkl@rk	•	
I hereby declare that all statements medief are believed to be true; and further so made are punishable by fine of willful false statements may Jeopardiz Full name of sole or first inventor (giventor's signature Seoul, Korea Post Office Address Samsungcheo	ther that these statements were imprisonment, or both, under the validity of the application on name, family name) Whate Whate	re made with the knowledge that we rescaled 1001 of Title 18 of the United and the resonance of the Lee of the	villful false statements and the nited States Code and that such NAME)
- · · · · · · · · · · · · · · · · · · ·			
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